ON Semiconductor®



4- and 8-Channel EMI Filter Arrays with ESD Protection

CM1436

Features

- Four, six and eight channels of EMI filtering with ESD protection
- Greater than 30dB of attenuation from 800MHz to 3GHz
- ±15kV ESD protection (IEC 61000-4-2, contact discharge)
- ±30kV ESD protection (HBM)
- Fabricated with Centurion[™] advanced low capacitance zener process technology
- Space saving, low-profile 8-, 12- and 16-lead 0.4mm pitch TDFN packages
- Lead-free version available

Applications

- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- EMI filtering for LCD, camera and chip-to-chip data lines

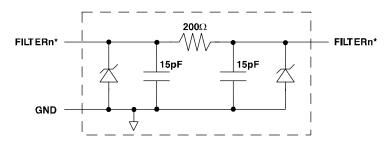
Product Description

The CM1436 is an EMI filter array with ESD protection, which integrates either four, six or eight pi filters (C-R-C). Each CM1436 filter has component values of 15pF-200 Ω -15pF. These parts include ESD protection diodes on every pin, providing a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of $\pm 15 \mathrm{kV}$ contact discharge, twice the specification requirement of the IEC 61000-4-2, Level 4 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than $\pm 30 \mathrm{kV}$.

This device is particularly well-suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy-to-use pin assignments. In particular, the CM1436 is ideal for EMI filtering and protecting data lines from ESD in wireless handsets.

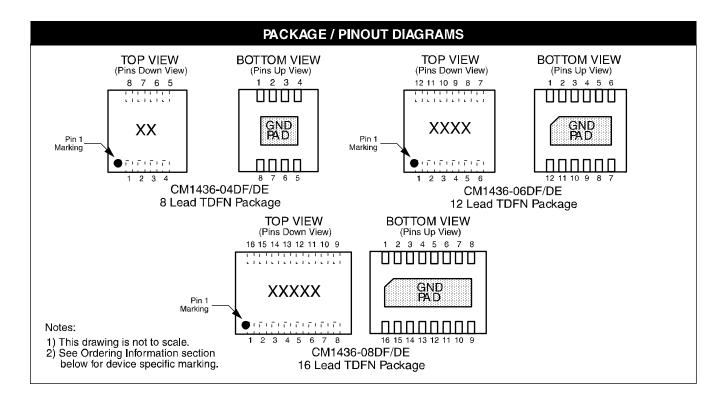
The CM1436 is available in space-saving, low-profile, 8-lead, 12-lead and 16-lead 0.4mm pitch TDFN packages. It is fabricated with $Centurion^{TM}$ process and available with lead-free finishing.

Electrical Schematic



1 of 4/6/8 EMI Filtering + ESD Channels

* See Package/Pinout Diagram for expanded pin information.



PIN DESCRIPTIONS									
Pins						Pins			
1436- 04Dx	1436- 06Dx	1436- 08Dx	NAME	DESCRIPTION	1436- 04Dx	1436- 06Dx	1436- 08Dx	NAME	DESCRIPTION
1	1	1	FILTER1	Filter Channel 1	8	12	16	FILTER1	Filter Channel 1
2	2	2	FILTER2	Filter Channel 2	7	11	15	FILTER2	Filter Channel 2
3	3	3	FILTER3	Filter Channel 3	6	10	14	FILTER3	Filter Channel 3
4	4	4	FILTER4	Filter Channel 4	5	9	13	FILTER4	Filter Channel 4
	5	5	FILTER5	Filter Channel 5		8	12	FILTER5	Filter Channel 5
	6	6	FILTER6	Filter Channel 6		7	11	FILTER6	Filter Channel 6
		7	FILTER7	Filter Channel 7			10	FILTER7	Filter Channel 7
		8	FILTER8	Filter Channel 8			9	FILTER8	Filter Channel 8
GND Pad			GND	Device Ground					

Ordering Information

PART NUMBERING INFORMATION									
		Standard Finish Lead-free Finish							
Leads/Pins	Package	Ordering Part Number ¹	Part Marking	Ordering Part Number ¹	Part Marking				
8	TDFN-08	CM1436-04DF	6F	CM1436-04DE	6E				
12	TDFN-12	CM1436-06DF	N36F	CM1436-06DE	N36E				
16	TDFN-16	CM1436-08DF	N368F	CM1436-08DE	N368E				

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

CM1436

Specifications

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	RATING	UNITS					
Storage Temperature Range	-65 to +150	℃					
DC Power per Resistor	100	mW					
Package DC Power Rating	300	mW					

STANDARD OPERATING CONDITIONS								
PARAMETER	RATING	UNITS						
Operating Temperature Range	-40 to +85	℃						

ELECTRICAL OPERATING CHARACTERISTICS (SEE NOTE 1) **SYMBOL PARAMETER CONDITIONS** MIN **TYP** MAX **UNITS** R 160 Ω Resistance 200 240 С Capacitance At 2.5V DC, 1MHz, 30mV AC 12 15 18 pF Diode Standoff Voltage $I_{\text{DIODE}}\!=10\mu A$ ٧ V_{DIODE} 6.0 Diode Leakage Current (reverse $V_{\text{DIODE}} = 3.3V$ 0.1 1 μΑ \mathbf{I}_{LEAK} bias) Signal Voltage V_{SIG} $I_{LOAD} = 10mA$ Positive Clamp 5.6 6.8 9.0 V $I_{LOAD} = -10mA$ -0.4 -1.5 ٧ **Negative Clamp** -0.8 $\boldsymbol{V}_{\text{ESD}}$ In-system ESD Withstand Voltage Note 2 a) Human Body Model, MIL-STD-±30 kV 883, Method 3015 b) Contact Discharge per IEC kV ±15 61000-4-2 Level 4 **Cut-off Frequency** $R = 200\Omega$, C = 15pF; f_{c} $Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega$ 100 MHz $$\begin{split} &Z_{\text{\tiny SOURCE}} = 50\Omega, \, Z_{\text{\tiny LOAD}} = 50\Omega, \\ &\text{DC Bias} = \text{OV; Notes 1} \end{split}$$ Absolute Attenuation @ 1GHz from dB 35 \mathbf{A}_{1GHz} 0dB Level Absolute Attenuation @ 800MHz to $Z_{\text{SOURCE}} = 50\Omega, \, Z_{\text{LOAD}} = 50\Omega, \,$ 30 dB A_{800MHz - 6GHz} 6GHz from 0dB Level DC Bias = 0V; Notes 1 and 3

Note 1: T_A=25 °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Attenuation / RF curves characterized by a network analyzer using microprobes.

Performance Information

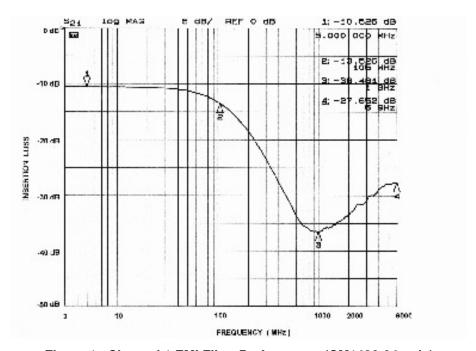


Figure 1. Channel 1 EMI Filter Performance (CM1436-04 only)

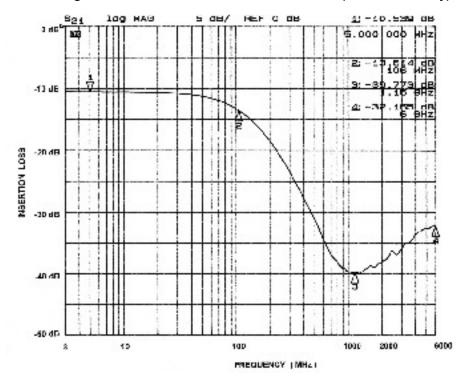


Figure 2. Channel 2 EMI Filter Performance (CM1436-04 only)

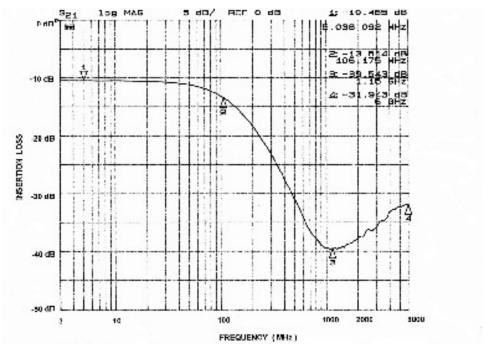


Figure 3. Channel 3 EMI Filter Performance (CM1436-04 only)

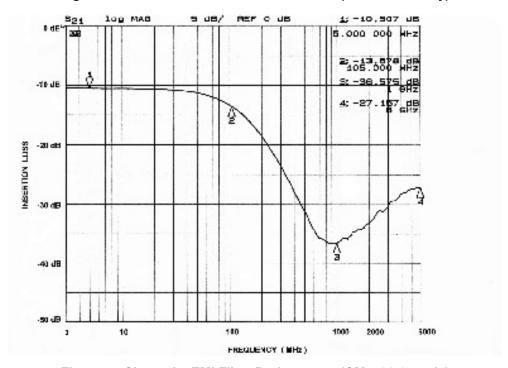


Figure 4. Channel 4 EMI Filter Performance (CM1436-04 only)

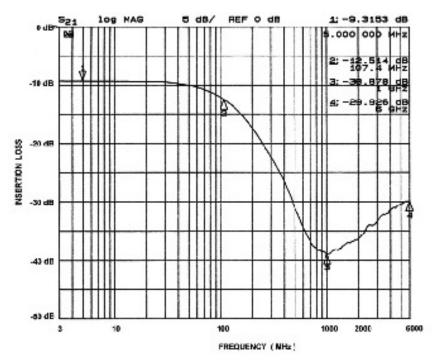


Figure 5. Channel 1 EMI Filter Performance (CM1436-06/08 only)

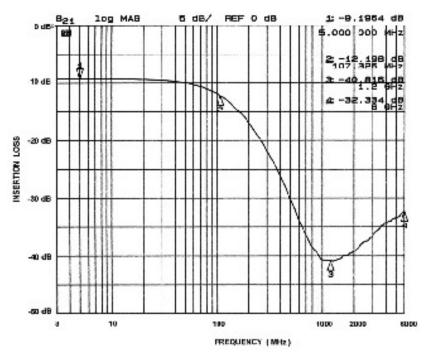


Figure 6. Channel 2 EMI Filter Performance (CM1436-06/08 only)

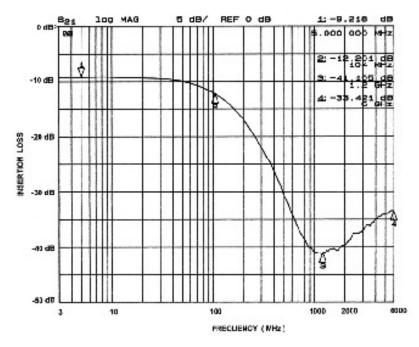


Figure 7. Channel 3 EMI Filter Performance (CM1436-06/08 only)

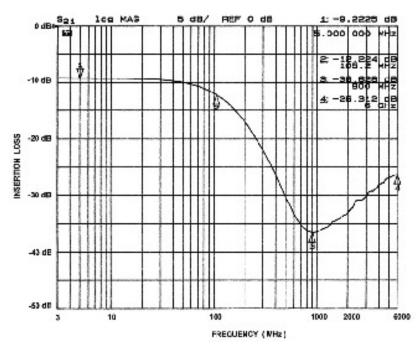


Figure 8. Channel 4 EMI Filter Performance (CM1436-06/08 only)

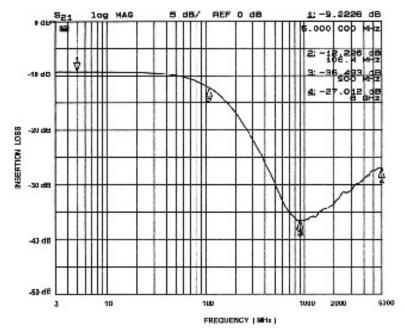


Figure 9. Channel 5 EMI Filter Performance (CM1436-06/08 only)

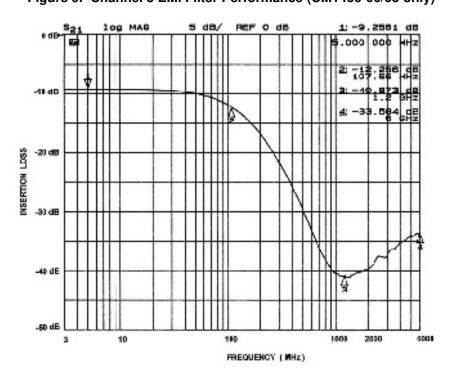


Figure 10. Channel 6 EMI Filter Performance (CM1436-06/08 only)

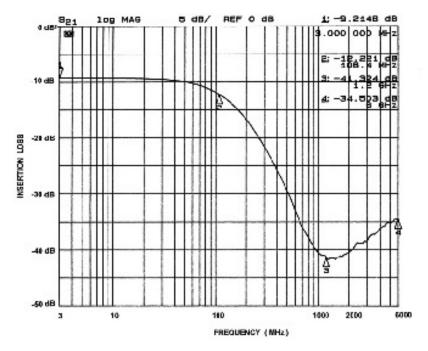


Figure 11. Channel 7 EMI Filter Performance (CM1436-08 only)

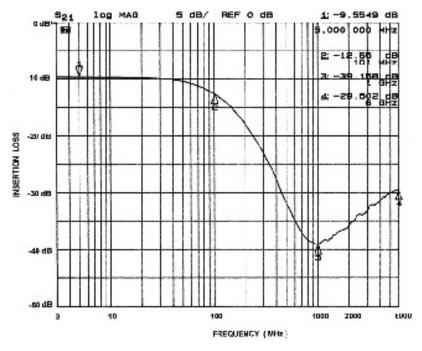


Figure 12. Channel 8 EMI Filter Performance (CM1436-08 only)

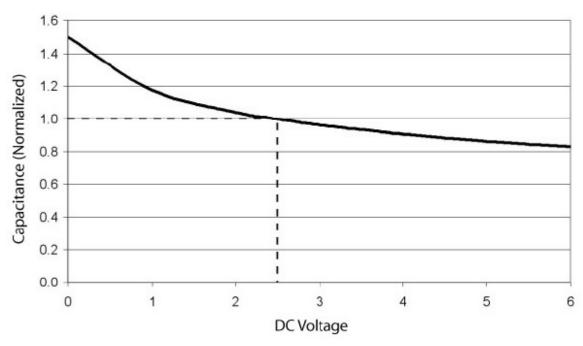


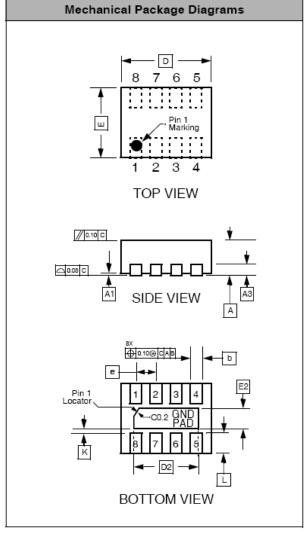
Figure 13. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5VDC and 25 ℃)

Mechanical Details

CM1436-04DF/DE Mechanical Specifications

Dimensions for the CM1436-04DF/DE supplied in a 8-lead, 0.4mm pitch TDFN package are presented below.

	PAC	KAGE	DIME	NSIO	NS			
Package	TDFN							
JEDEC No.	MO-229C [†]							
Leads				8				
Dim.	N	lillimete	rs	Inches				
Dilli.	Min	Nom	Max	Min	Nom	Max		
Α	0.70	0.75	0.80	0.028	0.030	0.031		
A 1	0.00	0.02	0.05	0.000	0.001	0.002		
А3	0.20 REF 0.008 REF				F			
b	0.15	0.20	0.25	0.006	0.008	0.010		
D	1.65	1.70	1.75	0.065	0.067	0.069		
D2	1.10	1.20	1.30	0.043	0.047	0.051		
E	1.30	1.35	1.40	0.051	0.053	0.055		
E2	0.30	0.40	0.50	0.012	0.016	0.020		
е	0.40 BSC 0.016 BSC					SC SC		
К	0.20			0.008				
L	0.15	0.25	0.35	0.006	0.010	0.014		
# per tape and reel	3000 pieces							
Controlling dimension: millimeters								



Dimensions for 8-Lead, 0.4mm pitch TDFN Package

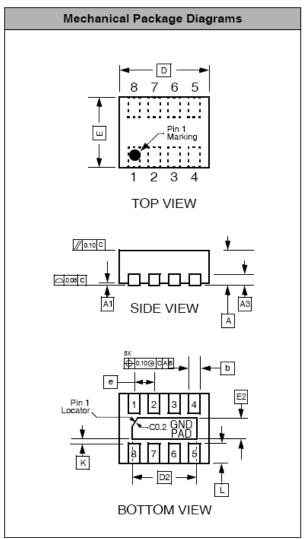
[†]This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.

Mechanical Details (cont'd)

CM1436-06DF/DE Mechanical Specifications

Dimensions for the CM1436-06DF/DE suplied in a 12-lead, 0.4mm pitch TDFN package are presented below. For complete information on the TDFN-12, see the California Micro Devices TDFN Package Information document.

	PAC	KAGE	DIME	NSIO	NS		
Package			TE	PFN			
JEDEC No.	MO-229C [†]						
Leads			1	12			
Dim.	N	lillimete	rs		Inches		
5	Min	Nom	Max	Min	Nom	Max	
Α	0.70	0.75	0.80	0.028	0.030	0.031	
A 1	0.00	0.02	0.05	0.000	0.001	0.002	
А3	(0.20 RE	F	0.008 REF			
b	0.15	0.20	0.25	0.006	0.008	0.010	
D	2.45	2.50	2.55	0.096	0.098	0.100	
D2	1.90	2.00	2.10	0.075	0.079	0.083	
E	1.30	1.35	1.40	0.051	0.053	0.055	
E2	0.25	0.35	0.45	0.010	0.014	0.018	
е	0.40 BSC 0.016 BSC					C	
К	0.20			0.008			
L	0.15	0.25	0.35	0.006	0.010	0.014	
# per tape and reel	3000 pieces						
Controlling dimension: millimeters							



Dimensions for 12-Lead, 0.4mm pitch TDFN package

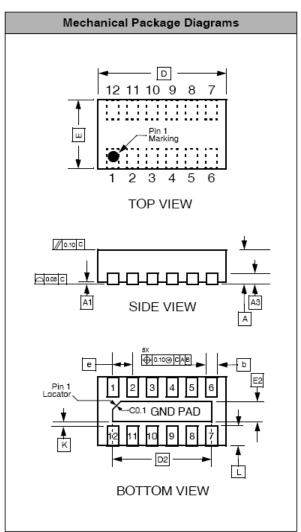
[†]This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.

Mechanical Details (cont'd)

CM1436-08DF/DE Mechanical Specifications

The CM1436-08DF/DE is supplied in a 16-lead, 0.4mm pitch TDFN package. Dimensions are presented below. For complete information on the TDFN-16, see the California Micro Devices TDFN Package Information document.

	PAC	KAGE	DIME	NSIO	NS			
Package	TDFN							
JEDEC No.	MO-229C [†]							
Leads			1	6				
Dim.	N	lillimete	rs	Inches				
Diiii.	Min	Nom	Max	Min	Nom	Max		
Α	0.70	0.75	0.80	0.028	0.030	0.031		
A 1	0.00	0.02	0.05	0.000	0.001	0.002		
А3	0.40	0.55	0.70	0.016	0.022	0.028		
b	0.20 REF 0.008 REF				F			
D	3.25	3.30	3.35	0.128	0.130	0.132		
D2	2.80	2.90	3.00	0.110	0.114	0.118		
E	1.30	1.35	1.40	0.051	0.053	0.055		
E2	0.35	0.40	0.45	0.014	0.016	0.018		
е	0.40 BSC 0.016 BSC							
К	0.20			0.008				
L	0.15	0.25	0.35	0.006	0.010	0.014		
# per tape and reel	3000 pieces							
Controlling dimension: millimeters								



Dimensions for 16-Lead, 0.4mm pitch TDFN package

[†]This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.

CM1436

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